L Number	Hits	Search Text	DB	Time stamp
-	144	system and substrate and ((polymer resin) and (magnetic	USPAT;	2004/05/28 09:56
		ferro\$2magnetic titanate barium adj strontium adj titanate	US-PGPUB	
		strontium adj tantalum adj oxide perovskite)) same (interconnect\$4 coupling adj component packaging) and		
	1	(print\$6 adj circuit adj board 'PCB' aluminum near2 frame	1	
		grid near2 array)		
-	1 2	(system and substrate and ((polymer resin) and (magnetic	USPAT:	2004/05/28 09:56
	_	ferro\$2magnetic titanate barium adj strontium adj titanate	US-PGPUB	2004/03/20 09.30
		strontium adj tantalum adj oxide perovskite)) same	00100	
		(interconnect\$4 coupling adj component packaging) and		
		(print\$6 adj circuit adj board 'PCB' aluminum near2 frame		
		grid near2 array)) and screen adj pad\$2		
-	4	screen adj pad and (printed adj circuit adj board 'PCB' grid	USPAT;	2004/05/28 09:57
		near5 array aluminum near2 frame) and (interconnect	US-PGPUB]
		packaging magnetically near5 align\$3)		
-	18	system and substrate and ((polymer resin) and (magnetic	USPAT;	2004/05/28 09:58
		ferro\$2magnetic titanate barium adj strontium adj titanate	US-PGPUB	
		strontium adj tantalum adj oxide perovskite)) same		
		(interconnect\$4 coupling adj component packaging) and		
		(print\$6 adj circuit adj board 'PCB' aluminum near2 frame		
		grid near2 array) and magnet\$\$7 near5 align\$3 and conductive near5 interconnect		
	37	(system and substrate and ((polymer resin) and (magnetic	USPAT;	2004/05/28 09:59
	"	ferro\$2magnetic titanate barium adj strontium adj titanate	US-PGPUB	2004/03/26 09.39
		strontium adj tantalum adj oxide perovskite)) same	00-1 01 00	
		(interconnect\$4 coupling adj component packaging) and		
		(print\$6 adj circuit adj board 'PCB' aluminum near2 frame		
		grid near2 array)) and (particle grain) near2 (size nano		
		nanosize micron ultra\$2fine) and (acicular near5 shape		
		(length width aspect diameter) near2 ratio)		
-	31	(system and substrate and ((polymer resin) and (magnetic	USPAT;	2004/05/28 10:00
		ferro\$2magnetic titanate barium adj strontium adj titanate	US-PGPUB	
		strontium adj tantalum adj oxide perovskite)) same		
		(interconnect\$4 coupling adj component packaging) and	1	
		(print\$6 adj circuit adj board 'PCB' aluminum near2 frame	1	
_	19	grid near2 array)) and (weight wt) near2 (ratio part '%') (system and substrate and ((polymer resin) and (magnetic	LICDAT	2004/05/20 40:00
_	13	ferro\$2magnetic titanate barium adj strontium adj titanate	USPAT; US-PGPUB	2004/05/28 10:00
		strontium adj tantalum adj oxide perovskite)) same	03-7-07-08	
		(interconnect\$4 coupling adj component packaging) and		
		(print\$6 adj circuit adj board 'PCB' aluminum near2 frame		
		grid near2 array)) and (photo\$2resist) and (thermal adj		
		expansion)		
-	24	((polymer thermoplastic thermoset photo\$2resist DNQ\$4	USPAT;	2004/05/28 10:00
		diazonaphthoquinone novolac epoxy polyamide) and	US-PGPUB	
		(magnetic ferro\$2magnetic titanate iron magnetite barium		
		adj strontium adj titanate strontium adj tantalum adj oxide		
		perovskite) and (particle powder fiber grain) near5 align\$4		
_	10	near5 magnetic) and conductive near5 interconnect (epoxy polyamide) and (magnetic ferro\$2magnetic titanate	LICDAT.	2004/05/00 40:00
	10	iron magnetite barium adj strontium adj titanate strontium adj	USPAT; US-PGPUB	2004/05/28 10:00
l		tantalum adj oxide perovskite) and (particle powder fiber	US-PGPUB	
		grain) near5 align\$4 near5 magnetic and conductive near5		
		interconnect		
-	18	(((polymer thermoplastic thermoset polyamide epoxy	EPO; JPO;	2004/05/28 10:01
		photo\$2resist DNQ\$4 diazonaphthoquinone novolac) and	DERWENT:	===
		(magnetic ferro\$2magnetic titanate iron magnetite	IBM_TDB	
		perovskite)) and (particle powder fiber grain) near5 align\$4)	-	
		and (conductive interconnect\$4 packag\$4)		
-	38	"5232661" "5536908" "5526978" "09023049"	USPAT;	2004/05/28 10:01
			US-PGPUB;	
			EPO; JPO;	
			DERWENT	